



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Lua et al.

**Serial No.:** 10/634,123

**Filed:** August 4, 2003

**For:** SEMICONDUCTOR SUBSTRATES  
INCLUDING I/O REDISTRIBUTION  
USING WIRE BONDS AND ANISO-  
TROPICALLY CONDUCTIVE FILM,  
METHODS OF FABRICATION AND  
ASSEMBLIES INCLUDING SAME

**Examiner:** Unknown

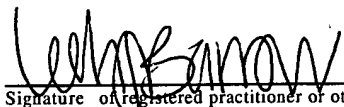
**Group Art Unit:** Unknown

**Attorney Docket No.:** 5709US (02-1462.00/US)

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail (under 37 C.F.R. § 1.8(a)) on the date of deposit shown below with sufficient postage and in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

September 18, 2003  
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Signature of registered practitioner or other person having reasonable basis to expect mailing to occur on date of deposit shown pursuant to 37 C.F.R. § 1.8(a)(1)(ii)

LEAH J. BARROW  
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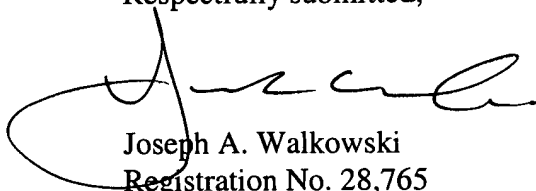
**COMMUNICATION**

Commissioner for Patents  
Washington, D.C. 20231

Sir:

Enclosed is a certified copy of priority document 200303830-4 filed July 22, 2003 concerning the above-referenced application.

Respectfully submitted,



Joseph A. Walkowski  
Registration No. 28,765  
Attorney for Applicants  
TRASKBRITT  
P. O. Box 2550  
Salt Lake City, Utah 84110-2550  
Telephone: (801) 532-1922

Date: September 18, 2003